GBL406-GBL408

4A STANDARD RECOVERY BRIDGE RECTIFIER

Product Summary

V_{RRM} (V)		I_F (A)	V_F Max (V) @ I_F = 2A	I_R Max (μA)
GBL406	600	4	1.0	5
GBL408	800			

Features

- Glass Passivated Die Construction
- Rating to 800V PRV
- Ideal for Printed Circuit Board
- Reliable Low Cost Construction Utilizing Molded Plastic
- UL Recognized File # E94661
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

Mechanical Data

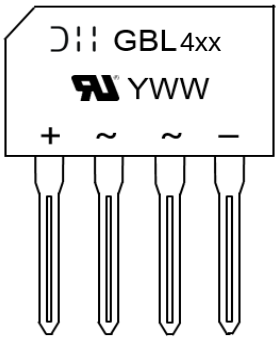
- Case: GBL
- Case Material: Plastic Material, UL Flammability Classification 94V-0 (No Br. Sb, Cl)
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 e3
- Polarity Indicator: Symbol Molded on Body
- Weight: 2.52 grams (Approximate)

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
GBL406	Commercial	GBL	25pcs/Tube
GBL408	Commercial	GBL	25pcs/Tube

Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



= Manufacturer's Marking
GBL4xx = Product Type Marking Code
YWW = Date Code Marking
Y = Year (ex: 1 = 2021)
WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	GBL406	GBL408	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	600	800	V
Maximum RMS Voltage		V_{RMS}	420	560	V
Maximum DC Blocking Voltage		V_{DC}	600	800	V
Maximum Average Rectified Output Current @ T_C = +100°C	With Heatsink Without Heatsink	$I_{F(AV)}$	4.0 2.4		A
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	T_J = +25°C T_J = +125°C	I_{FSM}	150 135		A
Peak Forward Surge Current 1.0ms Single Half Sine Wave Superimposed on Rated Load	T_J = +25°C T_J = +125°C	I_{FSM}	360 330		A
I^2t Rating for Fusing (t = 8.3ms)		I^2t	93		A^2s
Operating Temperature Range		T_J	-55 to + 150		°C
Storage Temperature Range		T_{STG}	-55 to + 150		°C

Electrical Characteristics

Characteristic	Test Conditions		Symbol	Max	Unit
Forward Voltage	I_F = 2A	T_J = +25°C	V_F	1.0	V
Leakage Current	V_R at Rated	T_J = +25°C T_J = +125°C	I_R	5 500	µA
Typical Junction Capacitance (Note 5)			C_J	35	pF

Thermal Characteristics

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Note 6)	$R_{\theta JC}$ $R_{\theta JL}$ $R_{\theta JA}$	4.2 4.0 10.0	°C/W

Notes: 5. Measured at 1.0MH_Z and applied reverse voltage of 4.0V DC.
6. Unit mounted on 50mm x 50mm x 1.6mm Cu plate heatsink.

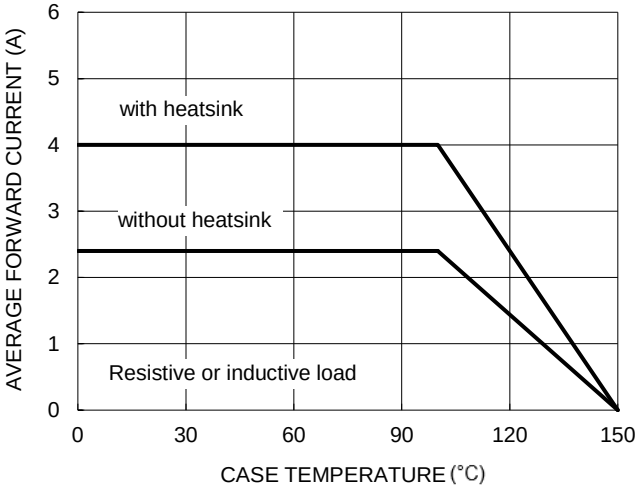


Figure 1. Forward Current Derating Curve

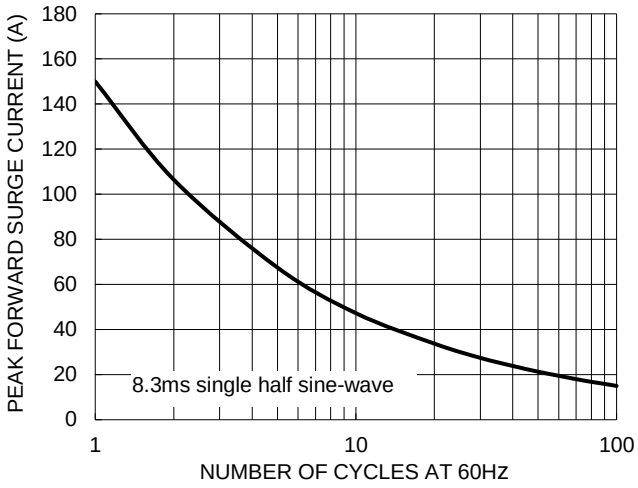


Figure 2. Maximum Non-Repetitive Surge Current

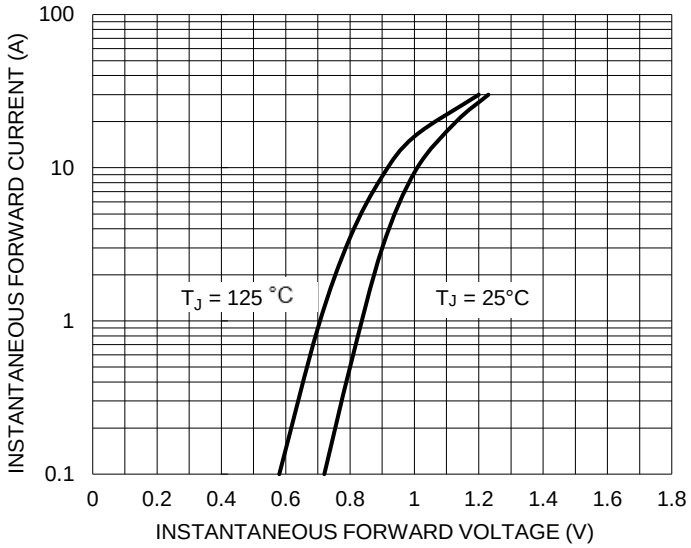


Figure 3. Typical Forward Characteristics

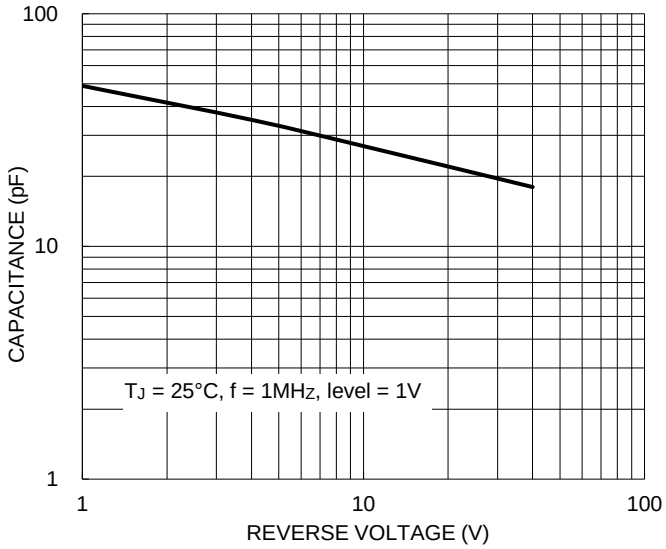


Figure 4. Typcial Junction Capacitance

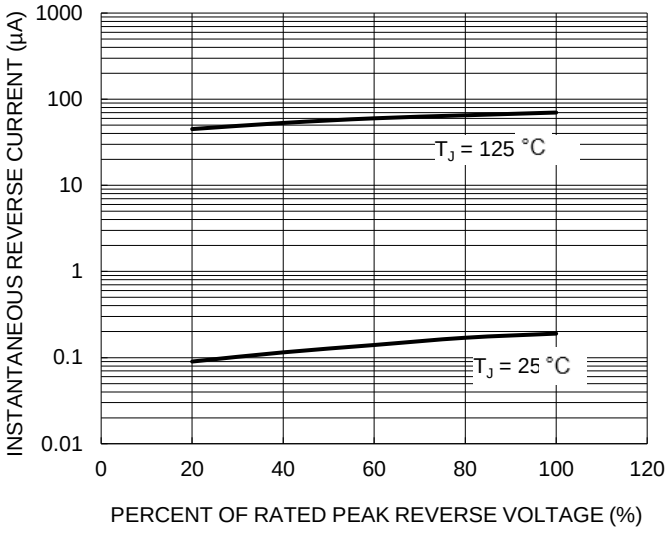


Figure 5. Typical Reverse Characteristics

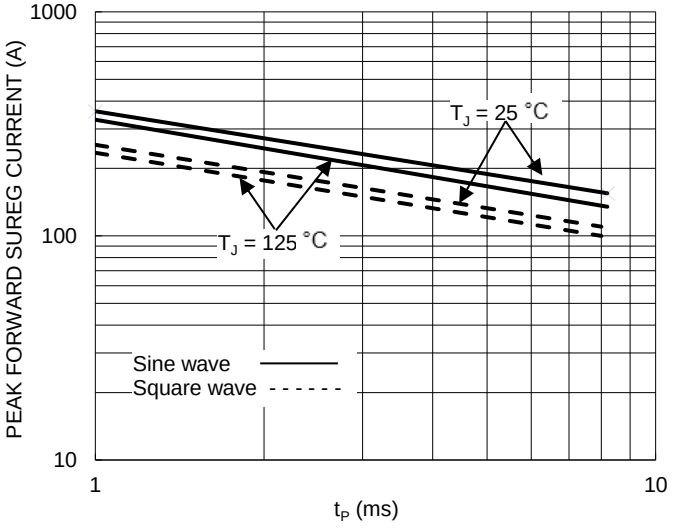
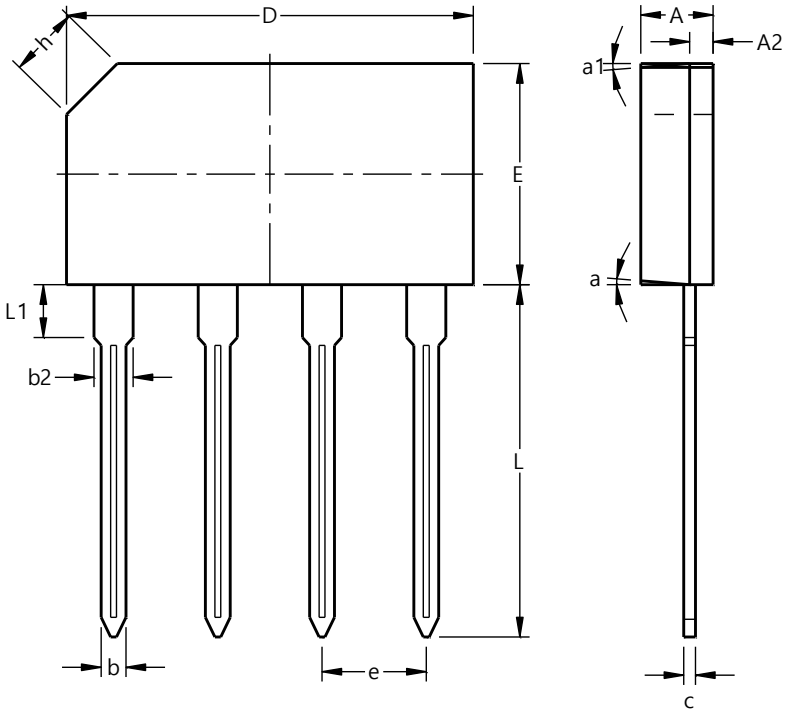


Figure 6. Non-Repetitive Surge Current

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

GBL



GBL			
Dim	**Min**	**Max**	**Typ.**
A	3.30	3.70	--
A2	0.80	1.20	--
b	1.02	1.27	--
b2	1.95	2.35	--
c	0.40	0.60	--
D	20.20	20.80	--
E	10.70	11.30	--
e	4.83	5.33	--
h	--	--	0.35
L	17.50	18.00	--
L1	2.30	2.70	--
a	--	5°	--
a1	--	5°	--
All Dimensions in mm			

IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5. Diodes products are provided subject to Diodes' Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

www.diodes.com